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## SPECIFICATION FOR LCM MODULE

MODULE NO.: ABG128064H05-YHY-R-01 DOC.REVISION 00

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		



## **DOCUMENT REVISION HISTORY**

Version	DATE	DESCRIPTION	CHANGED BY
00	May-6-2008	First issue	



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### 1. FUNCTIONS & FEATURES

1.1. Format : 128x64Dots

1.2. LCD mode : STN / Positive Transflective Mode/Y-G

1.3. Viewing direction : 6 O'clock

1.4. Driving scheme : 1/64 Duty cycle, 1/7 Bias

1.5. Power supply voltage  $(V_{DD})$  : 5.0V

1.6. LCD driving voltage : 7.2V Operating voltage)

1.7. Operation temp $: -20 \sim 70^{\circ} \text{C}$ 1.8. Storage temp $: -30 \sim 80^{\circ} \text{C}$ 1.9. Backlight color: Yellow-green

1.10.ROHS Standard

### 2. MECHANICAL SPECIFICATIONS

2.1. Module size : 75.0mm(L)\*52.8mm(W)\*9.0max mm(H)

2.2. Viewing area : 60.0\*mm(L)\*32.6mm(W)
2.3. Dot pitch : 0.43mm(L)\*0.43mm(W)
2.4. Dot size : 0.40mm(L)\*0.40mm(W)

2.5. Weight : Approx.

### 3. BLOCK DIAGRAM

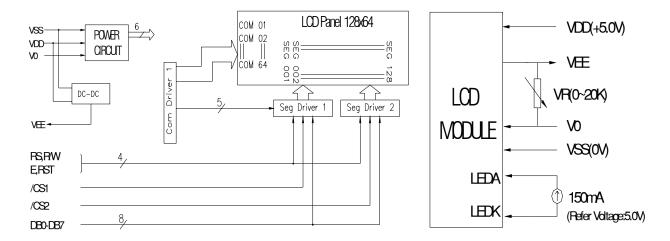


Figure 1. Block Diagram



4. DIMENSIONAL OUTLINE

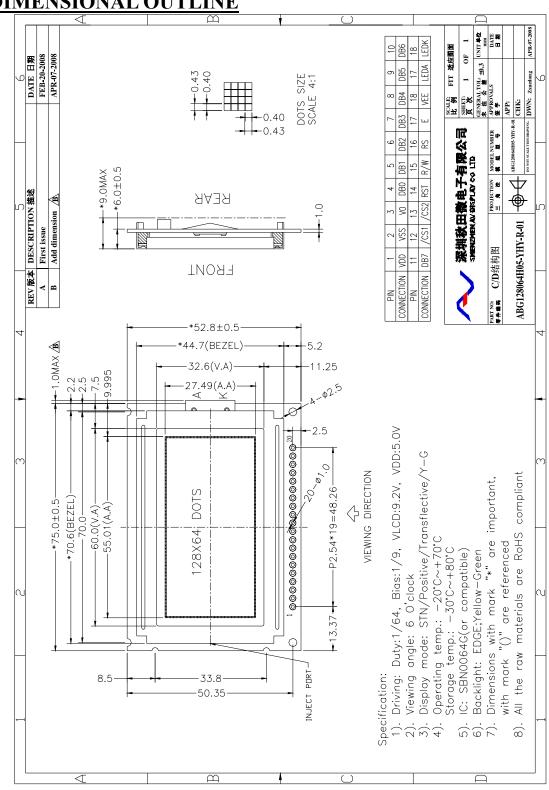


Figure 2. Dimensional Outline



## **5. PIN DESCRIPTION**

No.	Symbol	Function
1	VDD	Power supply(+5.0V)
2	VSS	GND(0V)
3	VO	Supply voltage for LCD
4~11	DB0~DB7	Data bus line
12	/CS1	Chip select signal for left half of the screen(Low select)
13	/CS2	Chip select signal for right half of the screen(Low select)
14	RST	Reset signal
15	R/W	Read /write selection. (H: Read L: write)
16	RS	Register selection. (H: Data register L: Instruction register)
17	Е	Enable signal for chip
18	VEE	Output of supply negative voltage by the DC-DC converter on the module
19	LEDA	Power supply for backlight(+)
20	LEDK	Power supply for backlight(-)

### **6. MAXIMUM ABSOUTE LIMIT**

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	$ m V_{DD}$	-0.3	7.0	V
Supply Voltage for LCD	V0	Vdd-16.0		V
Input Voltage	Vin	-0.3	V <sub>DD</sub> +0.3	V
Supply Current for Backlight	$I_F(Ta = 25^{\circ}C)$		150+150*20%	mA
Reverse Voltage for Backlight	$V_R(Ta = 25^{\circ}C)$		10	V
Operating Temperature	Тор	-20	70	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tst	-30	80	$^{\circ}\!\mathbb{C}$

### 7. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	V <sub>DD</sub> -V <sub>SS</sub>	$Ta = 25^{\circ}C$	4.75	5.0	5.25	V
Input High Voltage	VIH	$Ta = 25^{\circ}C$	V <sub>DD</sub> -2.2		$V_{\mathrm{DD}}$	V
Input Low Voltage	VIL	Ta = 25°C	0		0.8	V
Output High Voltage	Voh	$Ta = 25^{\circ}C$	V <sub>DD</sub> -0.3		$V_{\mathrm{DD}}$	V
Output Low Voltage	Vol	Ta = 25°C	0		0.3	V
Supply Current	Idd	Ta = 25°C		8	10	mA



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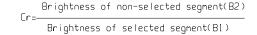
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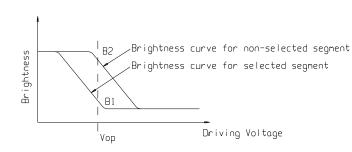
### 8. BACKLIGHT CHARACTERISTICS

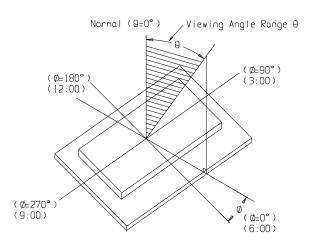
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF=150mA	4.0	4.2	4.4	V
Reverse Current	IR	VR=10V		0.1		mA
Luminous Intensity (Without	IV	IF=150mA	35	50		$Cd/m^2$
LCD)						
Wave length(Without LCD)	λρ	IF=150mA	569	572	574	nm
Color	Yellow-green					

# **9. ELECTRO-OPTICAL CHARACTERISTICS** (VDD=5.0V, Ta = 25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit
		Ta = -20C	7.3	7.7	8.1	
Operating Voltage	Vop	$Ta = 25^{\circ}C$	6.8	7.2	7.6	V
		Ta = 70C	6.3	6.7	7.1	
Dagnanga tima	Tr	Ta = 25°C		185		ms
Response time	Tf	1a-25 C		200		ms
Contrast	Cr	$Ta = 25^{\circ}C$		4		
Viewing angle range	θ	Cr≥2	-40		+40	deg
	Ф	C1 <u>~</u> 2	-40		+40	deg





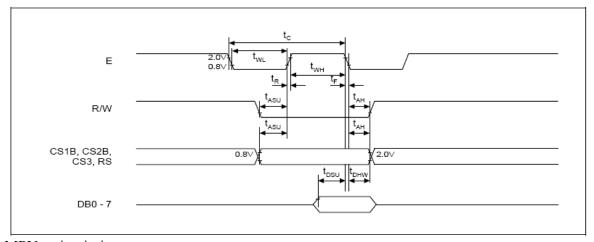




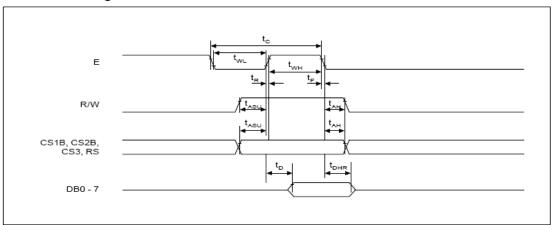
## 10. TIMING CHARACTERISTICS

(Please refer AVANT SBN0064G DATASHEES )

Characteristic	Symbol	Min	Тур	Max	Unit
E cycle	t <sub>C</sub>	1000	-	-	ns
E high level width	t <sub>WH</sub>	450	-	-	ns
E low level width	t <sub>WL</sub>	450	-	-	ns
E rise time	t <sub>R</sub>	-	-	25	ns
E fall time	t <sub>F</sub>	-	-	25	ns
Address set-up time	t <sub>ASU</sub>	140	-	-	ns
Address hold time	t <sub>AH</sub>	10	-	-	ns
Data set-up time	t <sub>DSU</sub>	200	-	-	ns
Data delay time	t <sub>D</sub>	-	-	320	ns
Data hold time (write)	t <sub>DHW</sub>	10	-	-	ns
Data hold time (read)	t <sub>DHR</sub>	20	-	-	ns



### MPU write timing



MPU read timing



# 11. CONTROL AND DISPLAY INSTRUCTION (Please refer AVANT SBN0064G DATASHEES )

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display on/off	L	L	L	L	Н	Н	Н	Н	Н	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L: OFF, H: ON
Set address (Y address)	L	L	L	Н		Y address (0 - 63)					Sets the Y address in the Y address counter.
Set page (X address)	L	L	Н	L	Н	Н	Н	Pa	ige (0 -	-7)	Sets the X address at the X address register.
Display start line (Z address)	L	L	Н	Н		Display start line (0 - 63)				Indicates the display data RAM displayed at the top of the screen.	
Status read	L	Н	Busy	L	On / Off	Reset	L	L	L	L	Read status. BUSY L: Ready H: In operation ON/OFF L: Display ON H: Display OFF RESET L: Normal H: Reset
Write display data	Н	L		Write data							Writes data (DB0:7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read display data	Н	Н				Read	l data				Reads data (DB0: 7) from display data RAM to the data bus.

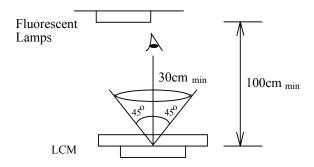


### **12.QUALITY SPECIFICATIONS**

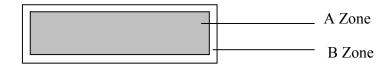
### 12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area). B Zone: Non-active display area (outside viewing area).



## 12.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: \* is not including)

Classify		Item	Note	AQL
Major Display state		Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	



### Note on defect classification

No.	Item			Criterio	on			
1	Short or open circuit		Not allow					
	LC leakage							
	Flickering	-						
	No display							
	Wrong viewing direction							
	Wrong Back-light							
2	Contrast defect		Refe	er to approv	val san	nple	-	
	Background color deviation							
3	Point defect, Black spot, dust	↓ ↓ Y		Poin Size		Acceptable Qty.		
	(including Polarizer)	X		φ <u>&lt;</u> 0.1		Disregard		
				0.10<♦≤		2		
	$\phi = (X+Y)/2$			0.20<¢≤ 0.25<¢≤		1		
				φ>0.23<φ<		0		
			Unit: mm					
4	Line defect,							
	G 4.1	W		Line		Acceptable Qty.		
	Scratch		L	0.015		Digragard	_	
		L	3.0≥	0.015 ≥ L 0.03 ≥		Disregard	-	
			2.0≥			2		
			1.0≥			1		
				0.05<	<w< td=""><td>Applied as point defect</td><td></td></w<>	Applied as point defect		
		Unit: mm						
5	Rainbow	Not more than tw	o colo	r changes a	icross t	the viewing area.		



No	Item	Criterion		
6	Chip  Remark: X: Length direction Y: Short	Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
	direction  Z: Thickness direction  t: Glass thickness W: Terminal Width	Acceptable criterion $\begin{array}{ c c c c c c c c c c c c c c c c c c c$		
		Acceptable criterion $\begin{array}{ c c c c c c c c }\hline X & Y & Z\\\hline \leqslant 3 & \leqslant 2 & \leqslant t\\\hline \text{shall not reach to ITO} \end{array}$		
		Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		



No.	Item	Criterion		
7	Segment pattern $W = Segment \ width$ $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10 \text{mm is acceptable.}$ $Y$		
8	Back-light	<ul><li>(1) The color of backlight should correspond its specification.</li><li>(2) Not allow flickering</li></ul>		
9	Soldering	(1) Not allow heavy dirty and solder ball on PCB.  (The size of dirty refer to point and dust defect)  (2) Over 50% of lead should be soldered on Land.  Lead  Land  50% lead		
10	Wire PCB	<ol> <li>(1) Copper wire should not be rusted</li> <li>(2) Not allow crack on copper wire connection.</li> <li>(3) Not allow reversing the position of the flat cable.</li> <li>(4) Not allow exposed copper wire inside the flat cable.</li> <li>(1) Not allow screw rust or damage.</li> <li>(2) Not allow missing or wrong putting of component.</li> </ol>		
11*	PCB	<ul><li>(1) Not allow screw rust or damage.</li><li>(2) Not allow missing or wrong putting of component.</li></ul>		



No	Item	Criterion	
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$	
13	TAB	1. Position $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
		2 TAB bonding strength test  TAB  P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min)  5pcs per SOA (shipment)	
14	Total no. of acceptable Defect	A. Zone  Maximum 2 minor non-conformities per one unit.  Defect distance: each point to be separated over 10mm  B. Zone  It is acceptable when it is no trouble for quality and assembly in customer's end product.	



### 12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment	
High temp. Storage	80°C	48		
High temp. Operating	70°C	48		
Low temp. Storage	-30°C	48	No abnormalities	
Low temp. Operating	-20°C	48	in functions	
Humidity	40°C/ 90%RH	48	and appearance	
Temp. Cycle	$0^{\circ}\text{C} \leftarrow 25^{\circ}\text{C} \rightarrow 50^{\circ}\text{C}$	10cycles		
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$			

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $20\pm8^{\circ}$ C), normal humidity (below  $45\pm20\%$  RH), and in the area not exposed to direct sun light. The life time is not content the life time of the LED (for the life time of LED which decay only 50%,in the industry the experience value is 50000 hours, but there are not any experimentation data to support this).

#### 12.4 Precaution for using LCD/ICM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

#### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting AV.



- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

### **Static Electricity Precautions:**

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.



7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

### **Limited Warranty**

AV LCDs and modules are not consumer products, but may be incorporated by AV's customers into consumer products or components thereof, AV does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of AV is limited to repair or replacement on the terms set forth below. AV will not
  be responsible for any subsequent or consequential events or injury or damage to any personnel
  or user including third party personnel and/or user. Unless otherwise agreed in writing between
  AV and the customer, AV will only replace or repair any of its LCD which is found defective
  electrically or visually when inspected in accordance with AV general LCD inspection standard.
  (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.